ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® international and Pa	PC. Bannockl	burn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarati the declaration e	on of the su	ibstances v s all lower	within the manufacture level materials for w	urer listed which the	item. Note: manufacture	if the item is an as er has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				rials and M	als and Mfg Information				
Supplier Information														
Company name* Con			Company unique ID			Unique ID Authority				Respo	Response Date*			
nsemi							,				2024-05-18			
ontact Name Title - Contact			ct	Pho			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Env.			nviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repre			esentative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Prod			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	mber Mfr Item Numb		Number Mfr Item Name			Effective Date	Effective Date Version Manufacturing		Ianufacturing Site		Weight*	UOM	Unit Type	
	FDT861	Г86106LZ FET 100V 108 mC		Ohm SOT223		2024-05-18		M	MY1		117.227	mg	Each	
Ianufacturing Proccess Informa	tion		·				-				·			
Terminal Plating / Grid Array M	aterial 7	ial Terminal Base Alloy		J-STD-020 MSI	L Rating	Peak Proce	Process Body Temperature Max Time at Pea		k Temper	ature Num	ber of Reflow Cyc	les		
Matte Tin (Sn) - annealed CU Al		CU Alloy	1			260 C		С	30 seco		seconds 3			
omments														
vel 1 - maximum time at peak temperat	ure during so	dering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chro	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in												
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).									
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the							
Supplier Digital Signature	astislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.54	mg	Supplier	Silicon (Si)	7440-21-3	_	1.54	mg
Die Attach Solder	0.541	mg	Supplier	Silver (Ag)	7440-22-4		0.0135	mg
			А	Lead (Pb)	7439-92-1	7a	0.5167	mg
			Supplier	Tin (Sn)	7440-31-5		0.0108	mg
Lead Frame	66.944	mg	Supplier	Silver (Ag)	7440-22-4		0.234	mg
			Supplier	Zinc (Zn)	7440-66-6		0.08	mg
			Supplier	Iron (Fe)	7439-89-6		1.61	mg
			Supplier	Copper (Cu)	7440-50-8		65	mg
			Supplier	Phosphorus (P)	7723-14-0		0.02	mg
Mold Compound-Black	39.687	mg		Epoxy resin	proprietary data		2.7781	mg
			Supplier	Phenolic Resin	Proprietary Data		1.1906	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		3.9687	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1984	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		31.5512	mg
Plating	8.29	mg	Supplier	Tin (Sn)	7440-31-5		8.29	mg
Wire Bond - Cu	0.225	mg	Supplier	Copper (Cu)	7440-50-8		0.225	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).